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On the triplet distribution and its effect on an improved phosphorescent organic light-emitting diode

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We reported phosphorescent organic light-emitting diodes with internal quantum efficiency near 100% with significantly reduced efficiency roll-off. It was found that the use of different hole transporting layer (HTL) affects the exciton distribution in the emission region significantly. Our best device reaches external quantum efficiency (EQE), current, and power efficiency of 22.8% ± 0.1%, 78.6 ± 0.2 cd/A, 85 ± 2 lm/W, respectively, with half current of 158.2 mA/cm². This considerably outperforms the control device with N,N'-bis(naphthalen-1-yl)-N,N'-bis(phenyl)-benzidine (NPB) (HTL) and 4,4',N,N'-dicarbazole-biphenyl (host) with maximum EQE, current and power efficiency of 19.1% ± 0.1%, 65.6 ± 0.3 cd/A, 67 ± 2 lm/W, respectively, with half current of only 8.1 mA/cm². © 2012 American Institute of Physics. [http://dx.doi.org/10.1063/1.4749278]

Organic light-emitting diodes (OLEDs) have been regarded as the next generation display and lighting technologies because of their potential to achieve high efficiency at low cost and flexible form factor. Since the first report of phosphorescent organic light emitting diodes (PHOLEDs) using fac tris(2-phenyl-pyridinato-N,C2) iridium (Ir(ppy)3) as phosphorescent dye,1 continuous efforts have been made to improve the external quantum efficiency (EQE) from an initial value of 8% to more than 20% recently.1–5

N,N'-bis(naphthalen-1-yl)-N,N'-bis(phenyl)-benzidine (NPB) has been extensively used as hole transporting layer (HTL), further studies on OLEDs with NPB used as HTL and 4,4',N,N'-dicarbazole-biphenyl (CBP): Ir(ppy)3 as an emission layer ( EML) showed that the recombination zone was close to the HTL/EML interface.6,7 However, such OLEDs were inefficient because of the lower triplet energy of NPB (2.3 eV) as compared to that of Ir(ppy)3 (2.4 eV).8,9 Therefore, material with higher triplet energy had to be used at the EML interface to confine the excitons within the EML. Recently 4,4',4'-tris(N-carbazolyl)triphenylamine (TCTA) has been used as HTL owing to its excellent hole mobility of around 10⁻⁹ cm²/V·s and high triplet energy of 2.7 eV.10,11 However, TCTA is not an ideal candidate for host layer due to its poor electron transport capability.11 CBP on the other hand has ambipolar charge transporting capability with both hole and electron mobilities around 10⁻⁶ cm²/V·s at an applied field of 0.5 MV/cm.11 Moreover, the HOMO level of 6.1 eV and LUMO of 2.8 eV of CBP are almost ideal for host with relatively wide bandgap.

In this paper, we use TCTA as the hole transporting layer and CBP as the host layer. Significant improvement was achieved compared to the control device that uses NPB as HTL. The EQE of the best device reaches 22.8% ± 0.1% with a maximum power efficiency of 85 ± 2 lm/W. The EQE roll-off was also significantly improved with TCTA as the HTL. At high current density of 22 mA/cm², the best EQE is almost doubled compared to the control device. To our knowledge, this is one of the highest reported EQEs for CBP host without external light out-coupling. We found that the triplet exciton distribution is significantly altered and the half current is improved by almost 20 times with the usage of TCTA compared to the control device with NPB as HTL. The improvement in the device performance results from better exciton distribution and confinement in the emission layer.12,13 The details of the device fabrication and measurement can be found elsewhere.14,15

Devices with the following configurations were fabricated: S1, ITO/MoO3 (10 nm)/NPB (60 nm)/CBP: Ir(ppy)3 (5%, 20 nm)/Bphen (50 nm)/LiF (1 nm)/Al (100 nm); S2, ITO/MoO3 (10 nm)/NPB (40 nm)/TCTA (20 nm)/CBP: Ir(ppy)3 (5%, 20 nm)/Bphen (50 nm)/LiF (1 nm)/Al (100 nm); and S3, ITO/MoO3 (10 nm)/TCTA (60 nm)/CBP: Ir(ppy)3 (5%, 20 nm)/Bphen (50 nm)/LiF (1 nm)/Al (100 nm). For all three devices, MoO3 is used as the hole injection layer (HIL), CBP: Ir(ppy)3 is the EML, 4,7-diphenyl-1,10-phenanthroline (Bphen) is the electron transport layer (ETL) and hole blocking layer (HBL), LiF is the electron injection layer (EIL), and Al is the cathode. The only difference among them is the choice of HTL, for the control device S1, NPB is used as HTL, while S2 uses NPB and TCTA as HTL, in device S3, TCTA serves as HTL. Figure 1 shows the structure and band diagram of various devices investigated in this work, the energy levels are extracted from literatures.4,16,17

Figure 2 shows the current density versus voltage (J-V) and luminance versus current density (L-J) curves for various

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devices shown in Figure 1. From Figure 2(a), it can be seen that all devices exhibit similar J-V characteristics, despite of the variation of the hole energy barrier and mobility, e.g., HOMO values of NPB and TCTA are 5.4 eV and 5.6 eV, respectively, and NPB has a slight larger hole mobility of $4 \times 10^{-4}$ cm$^2$/V/s as compared to TCTA ($1 \times 10^{-4}$ cm$^2$/V/s). The L-J curves on the other hand significantly differ for all devices. Figure 2(b) shows that S3 has much larger luminance, which implies improved recombination efficiency as compared to S1 and S2. At a low current density of 0.01 mA/cm$^2$, the operating voltage of devices S1, S2, and S3 are 3.0 V, 3.1 V, and 3.0 V, at a brightness level of 6.5 $\pm$ 0.2 cd/m$^2$, 6.4 $\pm$ 0.1 cd/m$^2$, and 7.9 $\pm$ 0.1 cd/m$^2$, respectively. The brightness reaches 6578 $\pm$ 74 cd/m$^2$, 9870 $\pm$ 110 cd/m$^2$, and 14245 $\pm$ 77 cd/m$^2$, respectively, at the same current density of 22.2 mA/cm$^2$.

Figure 3 shows the EQE, current, and power efficiency versus current density for devices S1, S2, and S3. Compared to the control device S1, which has maximum power efficiency (current efficiency) of 67 $\pm$ 2 lm/W (65.6 $\pm$ 0.3 cd/A), S2 shows a similar performance with power efficiency (current efficiency) of 66 $\pm$ 1 lm/W (63.7 $\pm$ 0.6 cd/A), while S3 has improved performance with maximum power efficiency (current efficiency) of 85 $\pm$ 2 lm/W (78.6 $\pm$ 0.2 cd/A). Furthermore, the control device S1 shows significant efficiency roll-off, for example, the efficiency drops from 61 $\pm$ 1 cd/A (54.6 $\pm$ 0.3 lm/W) to 49.0 $\pm$ 0.4 cd/A (24.6 $\pm$ 0.3 lm/W). The control device S1 has a peak EQE of only 19.1 $\pm$ 0.1%, while S2 and S3 reach higher EQE of 19.9% $\pm$ 0.1% and 22.8% $\pm$ 0.1%, respectively. The EQE roll-off of S2 and S3 has also improved significantly compared to S1. To ensure device S1 is optimized, we fabricated devices with different NPB thickness, ITO/MoO$_3$ (10 nm)/NPB (X nm)/CBP: Ir(ppy)$_3$ (5%, 20 nm)/Bphen (50 nm)/LiF (1 nm)/Al (100 nm), where X is set to 40, 50, 60, and 70 nm, respectively. The inset of Figure 3(b) shows the maximum EQE of the device as a function of the NPB thickness. The device S1 with a NPB layer of 60 nm shows the best performance, and hence it is used as the control device.

To better understand the factors causing such significant improvement, we study the triplet exciton distribution for each device. To do so, we fabricated the following structures: E1, ITO/MoO$_3$ (10 nm)/NPB (60 nm)/CBP (X nm)/CBP: Ir(ppy)$_3$ (5%, 5 nm)/CBP (15 – X nm)/Bphen (50 nm)/LiF (1 nm)/Al (100 nm), E2, ITO/MoO$_3$ (10 nm)/NPB (40 nm)/TCTA (20 nm)/CBP (X nm)/CBP: Ir(ppy)$_3$ (5%, 5 nm)/CBP (15 – X nm)/Bphen (50 nm)/LiF (1 nm)/Al (100 nm), and E3, ITO/MoO$_3$ (10 nm)/TCTA (60 nm)/CBP (X nm)/CBP: Ir(ppy)$_3$ (5%, 5 nm)/CBP (15 – X nm)/Bphen (50 nm)/LiF (1 nm)/Al (100 nm). The 5 nm CBP: Ir(ppy)$_3$ EML acted as a sensing layer, by varying the value of X from 0 to 5 nm, 10 nm, and 15 nm, respectively, the average exciton distribution profile within the 20 nm thick CBP host layer can be revealed.

Inset of Figure 4(a) shows the average triplet exciton distribution profile (normalized EQE) within the host layer. It can be seen that triplet exciton distributions are significantly different for device E1, E2, and E3. The normalized EQE is fitted using the following diffusion equation:

$$\text{FIG. 1. Device structure and energy bands for S1, S2, and S3.}$$

$$\text{FIG. 2. (a) Current density versus voltage (J-V) and (b) luminance versus current density (L-J) for devices S1, S2, and S3.}$$
where \( A \) and \( B \) represent for the relative peak triplet exciton concentration at the CBP/HTL and CBP/Bphen interfaces, \( L_D \) is the diffusion length of triplet in CBP, and \( d \) is the thickness of EML. In our case, \( d = 20 \) nm. By fitting, we obtained the diffusion length \( L_D \) to be around 14 nm. The value of exciton diffusion length obtained here is smaller than 46 nm reported in the literature.\(^{19}\) This is perhaps due to the thin EML, where Forster resonance energy transfer (FRET) and Dexter energy transfer between host and guest still dominate the exciton distribution instead of direct exciton diffusion. \( A \) and \( B \) are 0.8 and 0.4 for \( E_1 \), 0.3 and 1.1 for \( E_2 \), 0.4 and 1.2 for \( E_3 \), respectively. The larger \( A \) value in \( E_1 \) indicates the peak exciton concentration is located at CBP/NPB interface, while the larger \( B \) values for \( E_2 \) and \( E_3 \) means the peak exciton concentration shifts to CBP/Bphen interface.

Figure 4(a) [(i)–(iii)] depicts the emission spectrum with respect to distance (X) between phosphorescent dopants sites to CBP/HTL interface for devices \( E_1 \), \( E_2 \), and \( E_3 \) at current density of 0.22 mA/cm\(^2\), respectively. From Figure 4(a) (i), where NPB is used as HTL, when the Ir(ppy)\(_3\) doping was placed at NPB/CBP interface (\( X = 0 \)), we mainly observed the emission spectrum with a peak around 510 nm. When the Ir(ppy)\(_3\) doping was moved towards the cathode side, however, we observed an additional blue emission with a peak around 460 nm, which corresponds to the emission of NPB.\(^{20}\) Furthermore, an increase in NPB emission is observed as the Ir(ppy)\(_3\) doping was moved away from the NPB/CBP interface. We can conclude that majority of excitons are formed at the NPB/CBP interface. This is why when the sensing layer was moved away from the interface, the blue emission is increased compared to green emission. EQE of device \( E_1 \) at \( X = 0 \) is very small (only around 5%), which indicates that most of Ir(ppy)\(_3\) triplet emission is quenched by the NPB. This is because triplet energy of NPB (2.3 eV)\(^{8}\) is lower compared to the triplet energy of Ir(ppy)\(_3\) (2.4 eV).\(^{9}\)

Figure 4(a) [(ii) and (iii)] shows the emission spectrum for device \( E_2 \) and \( E_3 \), respectively, where TCTA was placed at HTL/CBP interface. Regardless of the position of the sensing layer, only emission from Ir(ppy)\(_3\) was observed. This means that the structure provides a better exciton confinement within the emission layer. From the inset of Figure 4(a), we can clearly see that the exciton formation zone is located at CBP/Bphen interface for device \( E_2 \) and \( E_3 \), and \( E_3 \) has a more uniform exciton distribution compared to that of \( E_2 \). By relating the emission spectrum and triplet exciton distribution of \( E_1 \), \( E_2 \), and \( E_3 \) with the performance of \( S_1 \), \( S_2 \), and \( S_3 \), respectively, we can conclude that the more balanced exciton distribution and better confinement are the reasons why \( S_3 \) performs the best.

To understand the hidden reason why \( S_3 \) has a better exciton distribution over \( S_2 \) and \( S_1 \), we study the electrical behaviour of the hole only devices as follows: \( H_1 \), ITO/MoO\(_3\) (20 nm)/NPB (60 nm)/CBP (70 nm)/Al (100 nm), \( H_2 \), ITO/MoO\(_3\) (20 nm)/NPB (40 nm)/TCTA (20 nm)/CBP (70 nm)/Al (100 nm), and \( H_3 \), ITO/MoO\(_3\) (20 nm)/TCTA (60 nm)/CBP (70 nm)/Al (100 nm).

Figure 4(b) shows the current density of device \( H_1 \), \( H_2 \), and \( H_3 \). We observed that \( H_1 \) has the smallest current flow as compared to device \( H_2 \) and \( H_3 \). This is because for \( H_1 \), the holes need to overcome a large energy barrier (0.7 eV) at NPB/CBP interface. For device \( H_2 \), the addition of 20 nm TCTA layer introduces a step barrier that facilitates better
hole transport to the CBP. Improvement in hole injection and transport towards CBP/Bphen interface shifts the exciton formation zone toward CBP/Bphen interface. The use of TCTA layer only in device H3 eliminates the hole accumulation at the NPB/TCTA interface, which further improves the hole injection into the CBP layer as compared to H2, increasing the recombination efficiency. A recent study in the literature showed that a universal energy alignment trend between transition oxide and organic semiconductors, if the Fermi level of the oxide lies below the HOMO of the organic semiconductors, the HOMO level of the organic material will be pinned at the Fermi level of the oxide, this will result in efficient charge injection from oxide into organic semiconductors. Therefore, because of the much deeper lying LUMO (6.7 eV) of MoO3 as compared to the HOMO values of NPB tors. Therefore, because of the much deeper lying LUMO (5.4 eV) and TCTA (5.6 eV), efficient hole injection from MoO3 into both NPB and TCTA was anticipated. The elimination of multiple interfaces and a smaller hole energy-barrier at TCTA/CBP for device S3 therefore improves the exciton toward NPB at higher current due to lower triplet lifetime (5.4 eV) and TCTA (5.6 eV), efficient hole injection from oxide into organic semiconductors, if the Fermi level of the oxide lies below the HOMO of the organic semiconductors, the HOMO level of the organic material will be pinned at the Fermi level of the oxide, this will result in efficient charge injection from oxide into organic semiconductors. Therefore, because of the much deeper lying LUMO (6.7 eV) of MoO3 as compared to the HOMO values of NPB tors. Therefore, because of the much deeper lying LUMO (5.4 eV) and TCTA (5.6 eV), efficient hole injection from MoO3 into both NPB and TCTA was anticipated. The elimination of multiple interfaces and a smaller hole energy-barrier at TCTA/CBP for device S3 therefore improves the exciton toward NPB at higher current due to lower triplet lifetime (5.4 eV) and TCTA (5.6 eV), efficient hole injection from oxide into organic semiconductors. Therefore, because of the much deeper lying LUMO (6.7 eV) of MoO3 as compared to the HOMO values of NPB tors. Therefore, because of the much deeper lying LUMO (5.4 eV) and TCTA (5.6 eV), efficient hole injection from MoO3 into both NPB and TCTA was anticipated.

The severe EQE roll-off for S1 is caused by the leakage of exciton toward NPB at higher current due to lower triplet energy bandgap. Therefore, it is imperative to have TCTA at the interface for a better confinement. For device S3, the excitons are more evenly distributed, and TTA is thus less severe.

In conclusion, we have reported a highly efficient OLED with EQE of 22.8% ± 0.1% and power efficiency of 85 ± 2 lm/W without external out-coupling. This was achieved by employing TCTA as the HTL and CBP as host layer. With better triplet exciton distribution and confinement, the efficiency roll-off was significantly reduced with much improved half current density of 158.2 mA/cm².

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